PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:		NEW ASSIGNMENT		
NATURE OF CONVEYANCE:		ASSIGNMENT		
CONVEYING PARTY	DATA			
N.		Name	Execution Date	
Minoru HATASE 08/01/2011			08/01/2011	
RECEIVING PARTY D	ATA			
Name:	Murata Manufacturing Co., Ltd.			
Street Address:	10-1 Higashikotari 1-chome			
City:	Nagaokakyo-shi, Kyoto-fu			
State/Country:	JAPAN			
Postal Code:	617-8555			
PROPERTY NUMBERS Total: 1				
Property Type		Number		
Application Number: 1319		197810		13197810
CORRESPONDENCE DATA				
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ATTORNEY DOCKET NUMBER:				
ATTORNEY DOCKET	NUMBER:	36856.2281		
ATTORNEY DOCKET		36856.2281 Michelle Rhodes		

Attorney Docket No.: 36856.2281

ASSIGNMENT (WORLDWIDE)

WHEREAS I, Minoru HATASE (hereinafter referred to as ASSIGNOR), have invented and own a certain Invention entitled METHOD FOR MANUFACTURING MODULE WITH PLANAR COIL, AND MODULE WITH PLANAR COIL for which application for Letters Patent of the United States has been

executed on even date herewith; x____ filed on _______as Serial No. ________.

WHEREAS, Murata Manufacturing Co., Ltd., 10-1, Higashikotari 1-chome, Nagaokakyo-shi, Kyoto-fu Japan 617-8555 (hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire interest in, to and under said invention and the United States Letters Patent to be obtained therefor;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the full and exclusive right, title and interest to the said invention and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for the full term or terms for which the same may be granted; and all Letters Patent and applications therefor through the world, including all the rights accruing by virtue of the International Convention for the Protection of Industrial Property.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.

Dated: 1/August/2011 Minoru HATASE _____

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RECORDED: 08/04/2011